

Label with CE, FCC, IC and TELEC mark information is placed on top of the module and is clearly visible.

Figure 1: Label placed on top of the module.

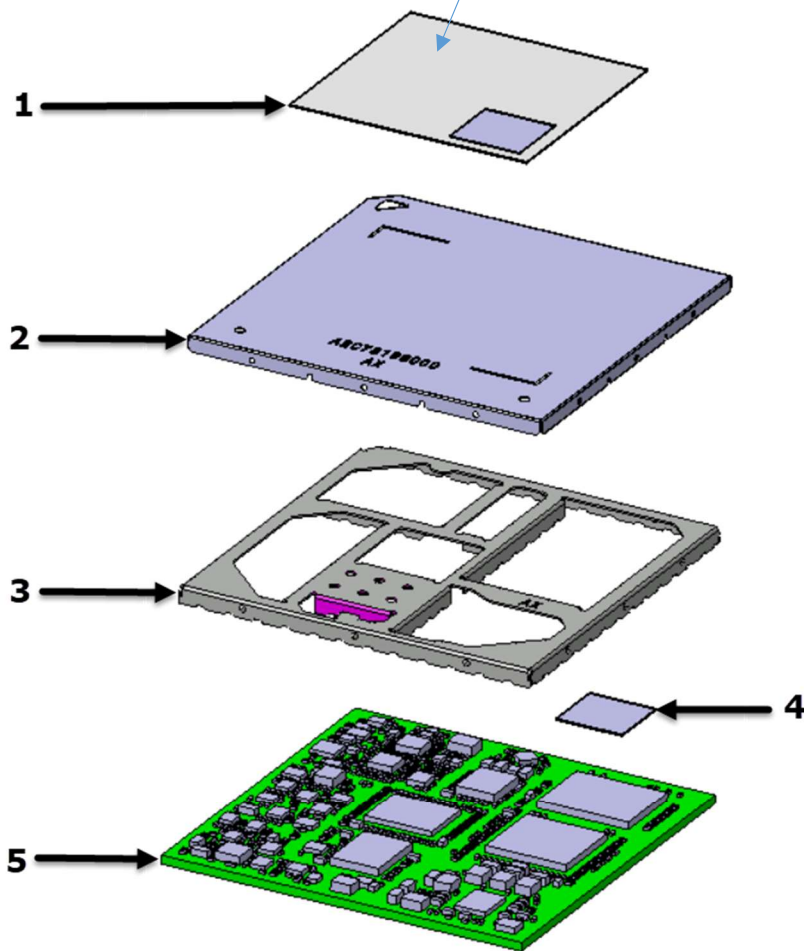


Figure 2: Module Exploded View

- 1: Label
- 2: Shield cover
- 3: Shield frame
- 4: Memory label
- 5: PCB Assembly